



# Product Change Notification

**Change Notification #:** 116497 - 00  
**Change Title:** Select Intel® SSD 760p Series,  
Intel® SSD DC P4101 Series,  
Intel® SSD E 6100P Series,  
PCN 116497-00, Label, Label Update  
**Date of Publication:** September 25, 2018

**Key Characteristics of the Change:**  
Label

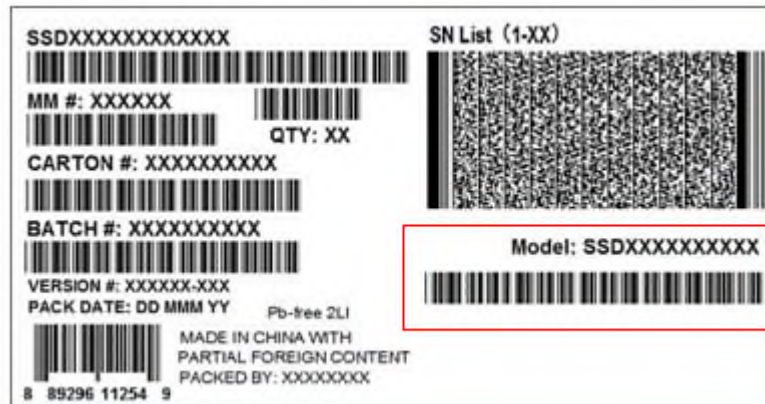
## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	December 24, 2018
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## Description of Change to the Customer:

The Intel® SSD 760p Series, Intel® SSD DC P4101 and Intel® SSD E 6100P Series SKUs listed in the Products Affected Table below will have the following label changes:

- Outer Box:
  - Add extra information ("Model") and linear barcode on the label with no change to current box label format and location.



2. White/Brown Box Label:

- Add extra information and linear barcode on the label.



**Customer Impact of Change and Recommended Action:**

The change in labeling only affects the label. There is no form, fit, function or visible change to the products listed in the Products Affected/Intel Order Codes table.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

**Products Affected / Intel Ordering Codes:**

Marketing Name	Product Code	MM#
Intel® SSD E 6100p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKR128G801	963756
Intel® SSD E 6100p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKR256G801	963758
Intel® SSD E 6100p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 10 Pack	SSDPEKKR128G810	963759
Intel® SSD E 6100p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 10 Pack	SSDPEKKR256G810	963760
Intel® SSD E 6100p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 50 Pack	SSDPEKKR128G8	963761
Intel® SSD E 6100p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic 50 Pack	SSDPEKKR256G8	963762
Intel® SSD 760p Series (128GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW128G801	963928
Intel® SSD 760p Series (256GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW256G801	963929
Intel® SSD 760p Series (512GB, M.2 80mm, PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKW512G801	963930
Intel® SSD DC P4101 Series (256GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKA256G801	976426
Intel® SSD DC P4101 Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKA512G801	976427
Intel® SSD DC P4101 Series (128GB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKA128G801	978509
Intel® SSD DC P4101 Series (1.024TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKA010T801	978511
Intel® SSD DC P4101 Series (2.048TB, M.2 80mm PCIe 3.0 x4, 3D2, TLC) Generic Single Pack	SSDPEKKA020T801	978513

**PCN Revision History:**

<b>Date of Revision:</b> September 25, 2018	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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